IN THE SPECIFICATION

Please amend the specification as follows:

<u>Page 5</u>, please replace the second paragraph with the following rewritten paragraph:

By this design, the present invention offers a cost-effective substitution for standard test wafers. Moreover, the present invention better simulates standard test wafers by ensuring that byproducts are produced simultaneously. The ratio of byproducts of the present invention may also be tailored to simulate a specific percentages percentage of area that is exposed through the process agent on a standard test wafer. This is accomplished by varying a

volumetric ratio between the process agent and material within the mixture.

<u>Page 9</u>, please replace the first paragraph with the following rewritten paragraph:

The method associated with the construction of the apparatus of the present invention will now be set forth with specific reference to Fig. 4. As mentioned earlier, the material 34 and the process agent 32, are combined to form the mixture. Note box 36 of Fig. 4. In the case where the material is aluminum in a powder form, such powder may be comprised of particulates with a size in the order of 20µm. It should be understood, however, that the

particulates may have any microscopic or macroscopic size.